## **Declaration for U.S. Patent Application**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original first and sole inventor (if only one name is listed below) or an original first and joint inventor (if plural

names are listed belo	ow) of the subject matte	r which is cla	imed and fo	or which a patent is soug	that on the invention entitled is attached hereto unless the following is
IXI	as filed on <u>June 30, 20</u> PCT/JP00/04392 and		_	=	T International Application Number blicable).
•	have reviewed and unde endment referred to abo		ntents of th	e above-identified specif	fication, including the claim(s), as
I acknowledge the d § 1.56.	uty to disclose informat	ion which is i	material to p	patentability as defined i	n Title 37, Code of Federal Regulations,
inventor's certificate		also identified	l below any	foreign application for	any foreign application(s) for patent or patent or inventor's certificate having a
<u> </u>					Priority Claimed
List prior Foreign applications.	(Number)	(Country)	(Day	/Month/Year Filed)	YesNo YesNo
See note A on back of this	(Number)	(Country)	(Day	/Month/Year Filed)	Yes No
page)	(Number)	(Country)	(Day	/Month/Year Filed)	YesNo
Table Charles	(Number)	(Country)	(Day	/Month/Year Filed)	<del></del>
See note B on back	of this page)	See atta	ched list fo	r additional prior foreig	n applications
subject matter of eac the first paragraph of as defined in Title 3	ch of the claims of this a Title 35, United States (	pplication is: Code, § 112, I Ilations, § 1.5	not disclose acknowled 66 which be	ed in the prior United Sta ge the duty to disclose in	olication(s) listed below and, insofar as the ates application in the manner provided by formation which is material to patentability the filing date of the prior application and
(List Prior U.S.					
Applications)	(Appln. Serial No.	) (Filing	g Date)	(Status: Patented, Pending, Abandoned)	
	(Appln. Serial No.)	) (Filing	g Date)	(Status: Patented, Pending, Abandoned)	
	(Appln. Serial No.)	) (Filing	g Date)	(Status: Patented, Pend	ding, Abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



Please direct all communications to the following address:



ATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C	Full name of sole or first inventor (given name, family name) Naoki MORITA					
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